CY23S09, CY23S05

Low Cost 3.3V Spread Aware Zero Delay Buffer

Features

- 10 MHz to 100 and 133 MHz Operating Range, compatible with CPU and PCI bus frequencies
- Zero Input-output Propagation Delay
- Multiple Low Skew Outputs
  - Output-output skew less than 250 ps
  - Device-device skew less than 700 ps
  - One input drives five outputs (CY23S05)
  - One input drives nine outputs, grouped as 4 + 4 + 1 (CY23S09)
- Less than 200 ps Cycle-to-cycle jitter is compatible with Pentium based systems
- Test mode to bypass PLL (CY23S09 only, see Select Input Decoding for CY23S09 on page 2)
- Available in space saving 16-pin, 150-mil SOIC, 4.4 mm TSSOP, and 150-mil SSOP (CY23S09) or 8-pin, 150-mil SOIC package (CY23S05)
- 3.3V operation, advanced 0.65µ CMOS Technology
- Spread Aware

Functional Description

The CY23S09 is a low cost 3.3V zero delay buffer designed to distribute high speed clocks and is available in a 16-pin SOIC package. The CY23S05 is an 8-pin version of the CY23S09. It accepts one reference input, and drives out five low skew clocks. The -1H versions of each device operate at up to 100 and 133 MHz frequencies and have higher drive than the -1 devices. All parts have on-chip PLLs that lock to an input clock on the REF pin. The PLL feedback is on-chip and is obtained from the CLKOUT pad.

The CY23S09 has two banks of four outputs each, which can be controlled by the select inputs as shown in the Select Input Decoding table on Select Input Decoding for CY23S09 on page 2. If all output clocks are not required, Bank B can be three-stated. The select inputs also allow the input clock to be directly applied to the outputs for chip and system testing purposes.

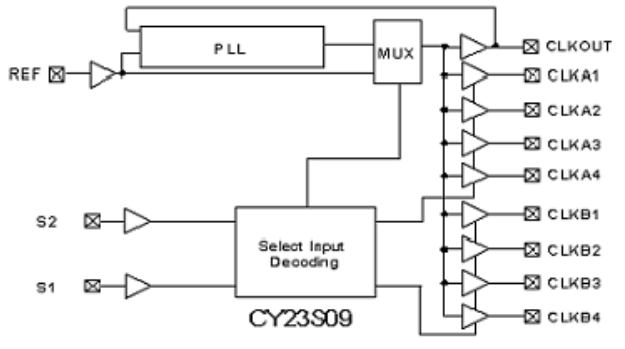
The CY23S09 and CY23S05 PLLs enter a power down mode when there are no rising edges on the REF input. In this state, the outputs are three-stated and the PLL is turned off, resulting in less than 12.0 µA of current draw (for commercial temperature devices) and 25.0 µA (for industrial temperature devices). The CY23S09 PLL shuts down in one additional case, as shown in the Select Input Decoding for CY23S09 on page 2.

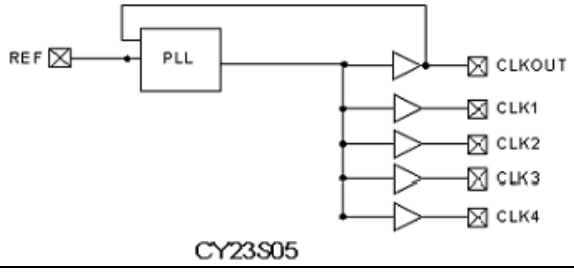
Multiple CY23S09 and CY23S05 devices can accept the same input clock and distribute it. In this case, the skew between the outputs of two devices is guaranteed to be less than 700 ps.

All outputs have less than 200 ps of cycle-to-cycle jitter. The input to output propagation delay on both devices is guaranteed to be less than 350 ps; the output to output skew is guaranteed to be less than 250 ps.

The CY23S05 and CY23S09 is available in two different configurations, as shown in the Ordering Information on page 6. The CY23S05-1 and CY23S09-1 is the base part. The CY23S05-1H and CY23S09-1H is the high drive version of the -1, and its rise and fall times are much faster than -1.

Logic Block Diagram





Select Input Decoding for CY23S09

S2	S1	CLOCK A1–A4	CLOCK B1–B4	CLKOUT[1]	Output Source	PLL Shutdown
0	0	Three-state	Three-state	Driven	PLL	N
0	1	Driven	Three-state	Driven	PLL	N
1	0	Driven	Driven	Driven	Reference	Y
1	1	Driven	Driven	Driven	PLL	N

Zero Delay and Skew Control

All outputs must be uniformly loaded to achieve Zero Delay between the input and output. Because the CLKOUT pin is the internal feedback to the PLL, its relative loading can adjust the input-output delay. This is shown in the above graph.

For applications requiring zero input-output delay, all outputs, including CLKOUT, must be equally loaded. Even if CLKOUT is not used, it must have a capacitive load equal to that on other outputs, to obtain zero input-output delay. If input to output delay adjustments are required, use the above graph to calculate loading differences between the CLKOUT pin and other outputs.

For zero output-output skew, be sure to load all outputs equally. For further information, refer to the application note “CY23S05 and CY23S09 as PCI and SDRAM Buffers.”

Spread Aware

Many systems being designed now use a technology called Spread Spectrum Frequency Timing Generation. Cypress is one of the pioneers of SSFTG development and designed this product so as not to filter off the Spread Spectrum feature of the Reference input, assuming it exists. When a zero delay buffer is not designed to pass the SS feature through, the result is a significant amount of tracking skew, which may cause problems in systems requiring synchronization.

For more details on Spread Spectrum timing technology, please see the Cypress application note AN1278, *EMI Suppression Techniques with Spread Spectrum Frequency Timing Generator (SSFTG) ICs*.

Pinouts

Figure 1. Pin Configuration – CY23S09

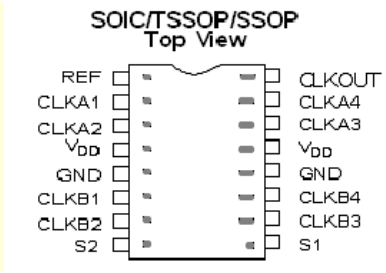
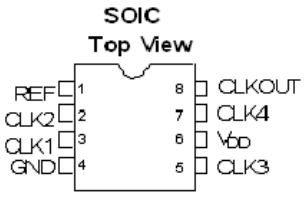


Figure 2. Pin Configuration – CY23S05



Note
1. This output is driven and has an internal feedback for the PLL. The load on this output can be adjusted to change the skew between the reference and output.

Table 1. Pin Description for CY23S09

Pin	Signal	Description
1	REF[2]	Input reference frequency, 5V tolerant input
2	CLKA1[3]	Buffered clock output, bank A
3	CLKA2[3]	Buffered clock output, bank A
4	V_{DD}	3.3V supply
5	GND	Ground
6	CLKB1[3]	Buffered clock output, bank B
7	CLKB2[3]	Buffered clock output, bank B
8	S2[4]	Select input, bit 2
9	S1[4]	Select input, bit 1
10	CLKB3[3]	Buffered clock output, bank B
11	CLKB4[3]	Buffered clock output, bank B
12	GND	Ground
13	V_{DD}	3.3V supply
14	CLKA3[3]	Buffered clock output, bank A
15	CLKA4[3]	Buffered clock output, bank A
16	CLKOUT[3]	Buffered output, internal feedback on this pin

Table 2. Pin Description for CY23S05

Pin	Signal	Description
1	REF[2]	Input reference frequency, 5V tolerant input
2	CLK2[3]	Buffered clock output
3	CLK1[3]	Buffered clock output
4	GND	Ground
5	CLK3[3]	Buffered clock output
6	V_{DD}	3.3V supply
7	CLK4[3]	Buffered clock output
8	CLKOUT[3]	Buffered clock output, internal feedback on this pin

Notes
2. Weak pull down.
3. Weak pull down on all outputs.
4. Weak pull up on these inputs.

Maximum Ratings

Supply Voltage to Ground Potential.....–0.5V to +7.0V
DC Input Voltage (Except REF) .....–0.5V to V_{DD} + 0.5V
DC Input Voltage REF .....–0.5V to 7V
Storage Temperature .....–65°C to +150°C
Maximum Soldering Temperature (10 seconds)..... 260°C
Junction Temperature ..... 150°C
Static Discharge Voltage
(per MIL-STD-883, Method 3015) .....> 2,000V

Operating Conditions for CY23S05SC-XX and CY23S09SC-XX Commercial Temperature Devices[5]

Parameter	Description	Min	Max	Unit
V_{DD}	Supply Voltage	3.0	3.6	V
T_A	Operating Temperature (Ambient Temperature)	0	70	°C
C_L	Load Capacitance, below 100 MHz		30	pF
C_L	Load Capacitance, from 100 MHz to 133 MHz		10	pF
C_{IN}	Input Capacitance		7	pF

Electrical Characteristics for CY23S05SC-XX and CY23S09SC-XX Commercial Temperature Devices

Parameter	Description	Test Conditions	Min	Max	Unit
V_{IL}	Input LOW Voltage[6]			0.8	V
V_{IH}	Input HIGH Voltage[6]		2.0		V
I_{IL}	Input LOW Current	V_{IN} = 0V		50.0	µA
I_{IH}	Input HIGH Current	V_{IN} = V_{DD}		100.0	µA
V_{OL}	Output LOW Voltage[7]	I_{OL} = 8 mA (–1) I_{OH} = 12 mA (–1H)		0.4	V
V_{OH}	Output HIGH Voltage[7]	I_{OH} = –8 mA (–1) I_{OL} = –12 mA (–1H)	2.4		V
I_{DD} (PD mode)	Power Down Supply Current	REF = 0 MHz		12.0	µA
I_{DD}	Supply Current	Unloaded outputs at 66.67 MHz, SEL inputs at V_{DD}		32.0	mA

Switching Characteristics for CY23S05SC-1 and CY23S09SC-1 Commercial Temperature Devices [8]

Parameter	Description	Test Conditions	Min	Typ	Max	Unit
t1	Output Frequency	30 pF load 10 pF load	10 10		100 133.33	MHz MHz
	Duty Cycle[7] = $t_2 \div t_1$	Measured at 1.4V, F_{out} = 66.67 MHz	40.0	50.0	60.0	%
t3	Rise Time[7]	Measured between 0.8V and 2.0V			2.50	ns
t_4	Fall Time[7]	Measured between 0.8V and 2.0V			2.50	ns
t_5	Output-to-Output Skew[7]	All outputs equally loaded			250	ps
t_6	Delay, REF Rising Edge to CLKOUT Rising Edge[7]	Measured at V_{DD}/2		0	±350	ps
t_7	Device-to-Device Skew[7]	Measured at V_{DD}/2 on the CLKOUT pins of devices		0	700	ps
t_J	Cycle-to-Cycle Jitter[7]	Measured at 66.67 MHz, loaded outputs			200	ps
t_{LOCK}	PLL Lock Time[7]	Stable power supply, valid clock presented on REF pin			1.0	ms

Notes
5. Multiple Supplies: The voltage on any input or I/O pin cannot exceed the power pin during power up. Power supply sequencing is NOT required.
6. REF input has a threshold voltage of V_{DD}/2.
7. Parameter is guaranteed by design and characterization. Not 100% tested in production.
8. All parameters specified with loaded outputs.

Switching Characteristics for CY23S05SI-1H and CY23S09SI-1H Industrial Temperature Devices[8]

Parameter	Description	Test Conditions	Min	Typ	Max	Unit
t1	Output Frequency	30 pF load 10 pF load	10 10		100 133.33	MHz MHz
	Duty Cycle[7] = $t_2 \div t_1$	Measured at 1.4V, F_{out} = 66.67 MHz	40.0	50.0	60.0	%
	Duty Cycle[7] = $t_2 \div t_1$	Measured at 1.4V, F_{out} <50.0 MHz	45.0	50.0	55.0	%
t3	Rise Time[7]	Measured between 0.8V and 2.0V			1.50	ns
t_4	Fall Time[7]	Measured between 0.8V and 2.0V			1.50	ns
t_5	Output-to-Output Skew[7]	All outputs equally loaded			250	ps
t_6	Delay, REF Rising Edge to CLKOUT Rising Edge[7]	Measured at $V_{DD}/2$		0	±350	ps
t_7	Device-to-Device Skew[7]	Measured at $V_{DD}/2$ on the CLKOUT pins of devices		0	700	ps
t_8	Output Slew Rate[7]	Measured between 0.8V and 2.0V using Test Circuit #2	1			V/ns
t_J	Cycle-to-Cycle Jitter[7]	Measured at 66.67 MHz, loaded outputs			200	ps
t_{LOCK}	PLL Lock Time[7]	Stable power supply, valid clock presented on REF pin			1.0	ms

Switching Waveforms

Figure 3. Duty Cycle Timing

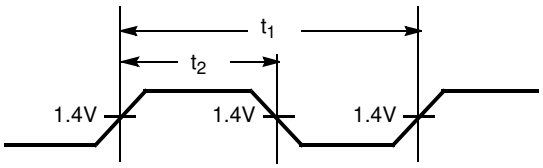


Figure 4. All Outputs Rise/Fall Time

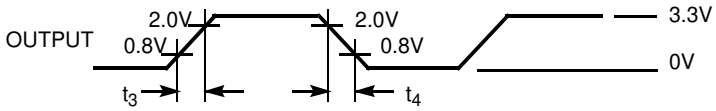


Figure 5. Output-Output Skew

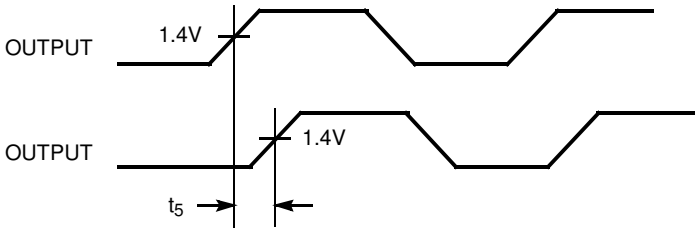
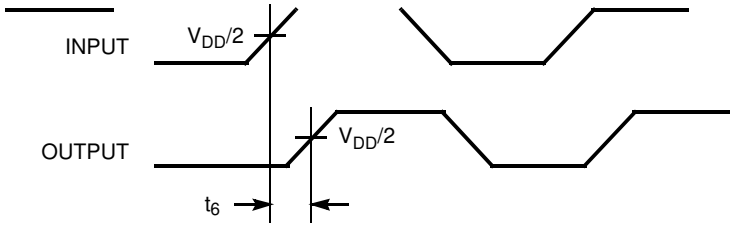
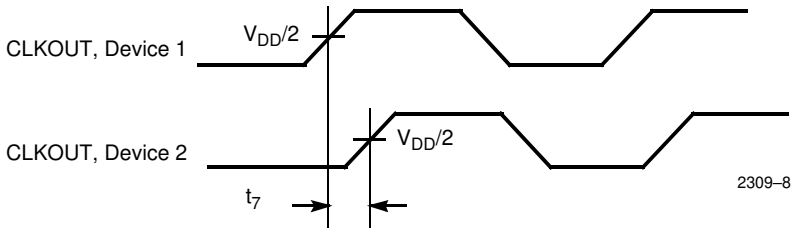


Figure 6. Input-Output Propagation Delay



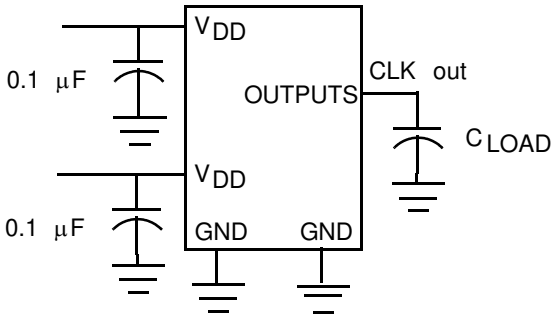
Switching Waveforms continued

Figure 7. Device-Device Skew

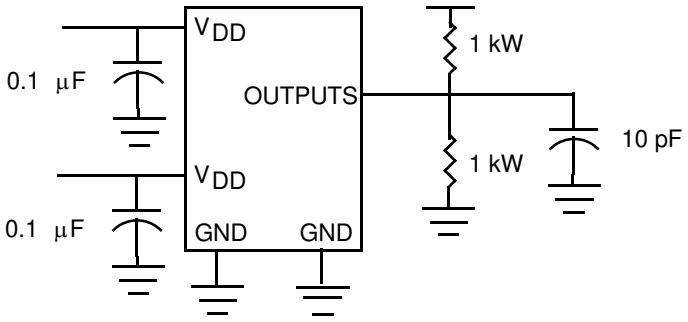


Test Circuits

Test Circuit # 1



Test Circuit # 2



For parameter t8 (output slew rate) on –1H devices

Ordering Information

Ordering Code	Package Name	Package Type	Operating Range
CY23S05SC-1[9]	S08	8-pin 150-mil SOIC	Commercial (0° to 70°C)
CY23S05SC-1H[9]	S08	8-pin 150-mil SOIC	Commercial (0° to 70°C)
CY23S09SC-1[9]	S16	16-pin 150-mil SOIC	Commercial (0° to 70°C)
CY23S09SC-1H[9]	S16	16-pin 150-mil SOIC	Commercial (0° to 70°C)
CY23S09ZC-1H[9]	Z16	16-pin 4.4 mm TSSOP	Commercial (0° to 70°C)
Pb-Free			
CY23S05SXC-1	SZ08	8-pin 150-mil SOIC	Commercial (0° to 70°C)
CY23S05SXC-1T	SZ08	8-pin 150-mil SOIC – Tape and Reel	Commercial (0° to 70°C)
CY23S05SXC-1H	SZ08	8-pin 150-mil SOIC	Commercial (0° to 70°C)
CY23S05SXC-1HT	SZ08	8-pin 150-mil SOIC – Tape and Reel	Commercial (0° to 70°C)
CY23S09SXC-1	SZ16	16-pin 150-mil SOIC	Commercial (0° to 70°C)
CY23S09SXC-1T	SZ16	16-pin 150-mil SOIC – Tape and Reel	Commercial (0° to 70°C)
CY23S09SXC-1H	SZ16	16-pin 150-mil SOIC	Commercial (0° to 70°C)
CY23S09SXC-1HT	SZ16	16-pin 150-mil SOIC – Tape and Reel	Commercial (0° to 70°C)
CY23S09ZXC-1H	ZZ16	16-pin 4.4 mm TSSOP	Commercial (0° to 70°C)
CY23S09ZXC-1HT	ZZ16	16-pin 4.4 mm TSSOP – Tape and Reel	Commercial (0° to 70°C)

Notes
9. Not recommended for new designs. New designs should use Pb-free devices.

Package Diagrams

Figure 8. 8-Pin (150-Mil) SOIC S08 and SZ08

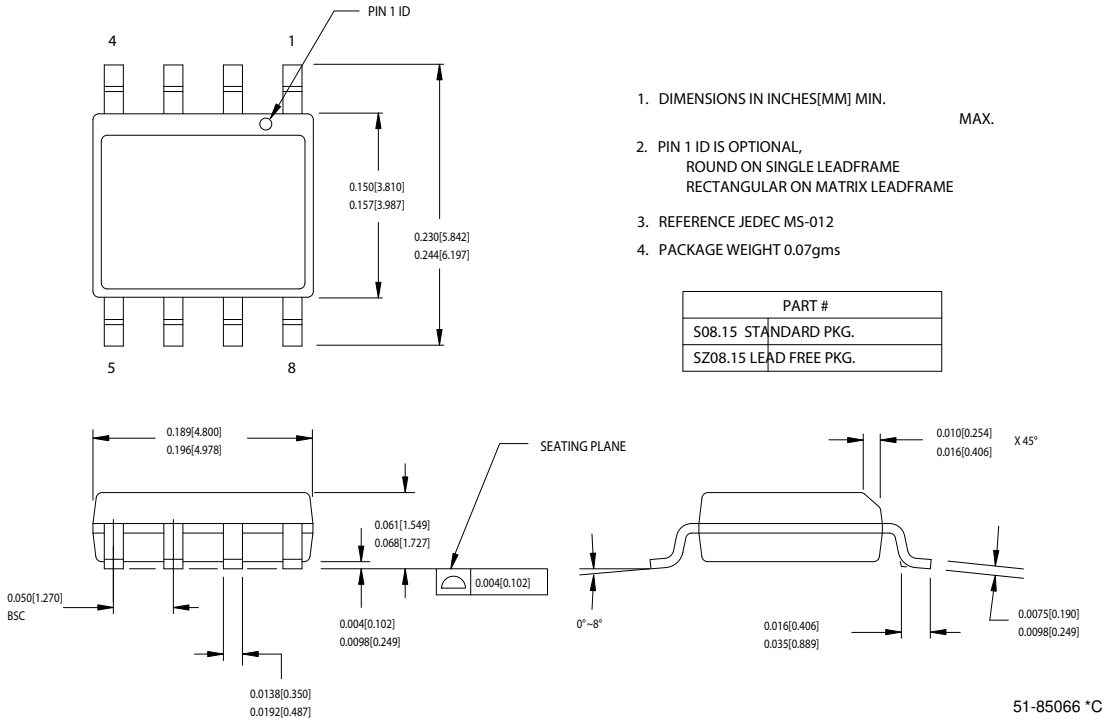
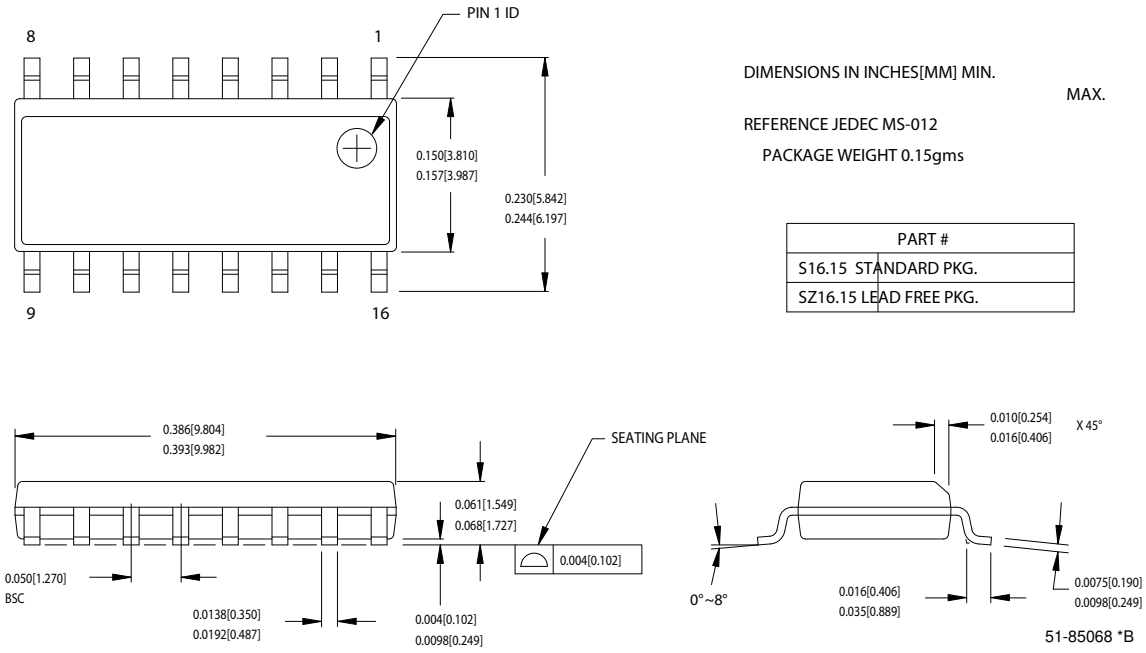
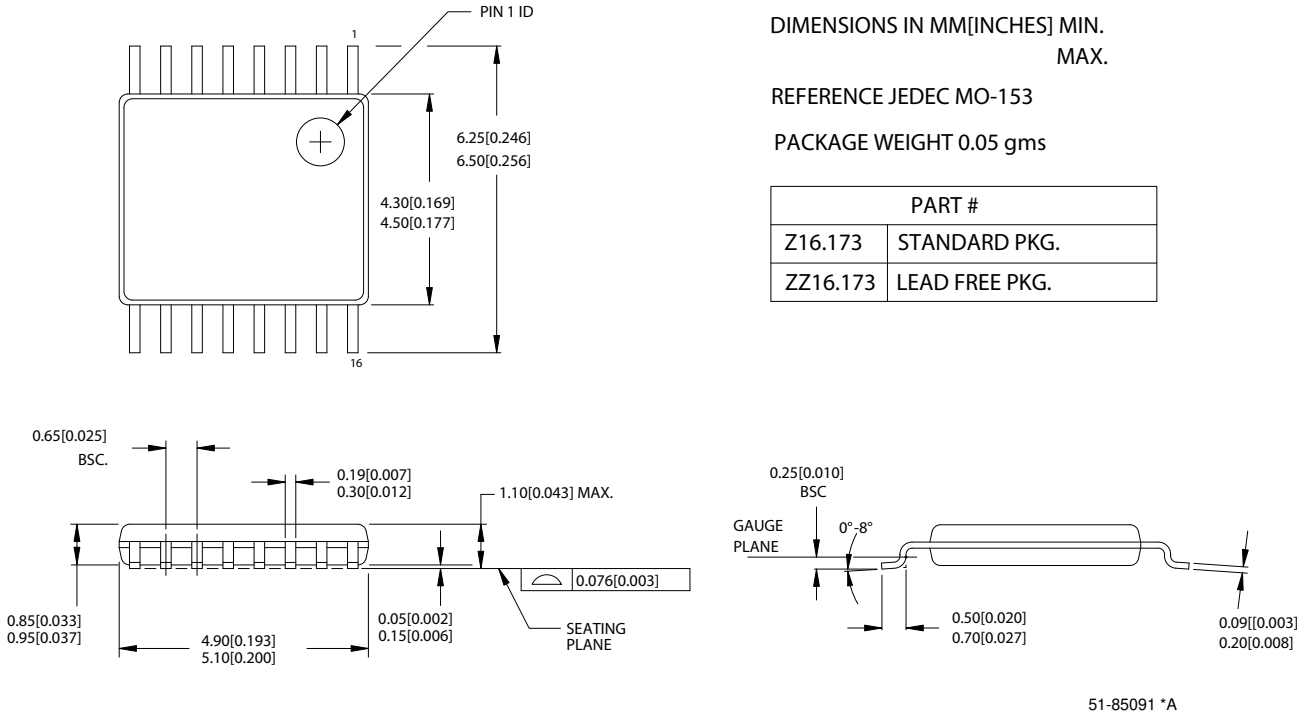


Figure 9. 16-Pin (150-Mil) SOIC S16 and SZ16



Package Diagrams continued

Figure 10. 16-Pin TSSOP 4.40 mm Body Z16 and ZZ16



Document History Page

Document Title: CY23S09/CY23S05 Low Cost 3.3V Spread Aware Zero Delay Buffer Document Number: 38-07296				
Rev.	**ECN No.**	**Submission Date**	**Orig. of Change**	**Description of Change**
**	111147	11/14/01	DSG	Changed from spec number 38-01094 to 38-07296
*A	111773	02/20/02	CTK	Added 150-mil SSOP option
*B	122885	12/22/02	RBI	Added power-up requirements to Operating Conditions
*C	267849	See ECN	RGL	Added Lead-Free devices
*D	2595524	10/23/08	CXQ/PYRS	Added device “Status” to Ordering Information
*E	2761988	09/10/09	KVM	Removed obsolete parts from Ordering Information table: CY23S09ZC-1, CY23S09OC-1, CY23S09OC-1H, CY23S09ZXC-1, CY23S09OXC-1, CY23S09OXC-1H. Added CY23S05SXC-1T, CY23S05SXC-1HT, CY23S09SXC-1T, CY23S09SXC-1HT, CY23S09ZXC-1HT. Removed Status column from Ordering Information table; added footnote. Updated package names and added numerical temperature range to Ordering Information table. Removed QSOP package drawing.

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